

How the composite structure of FR4 effects the prediction of impedance.

FR4 is a composite material, in most cases its a good approximation to assume a dielectric constant ϵ_r of 4.2, however research into the prediction of impedance of edge coupled differential and co planar structures has shown for the best results you need to take into account the composite structure of the material

The two main constituents of FR4 are glass with an ϵ_r of around 6 and resin with a dielectric constant of around 3. Typically manufacturers quote a dielectric constant for the composite "c" stage material of around 4.2.

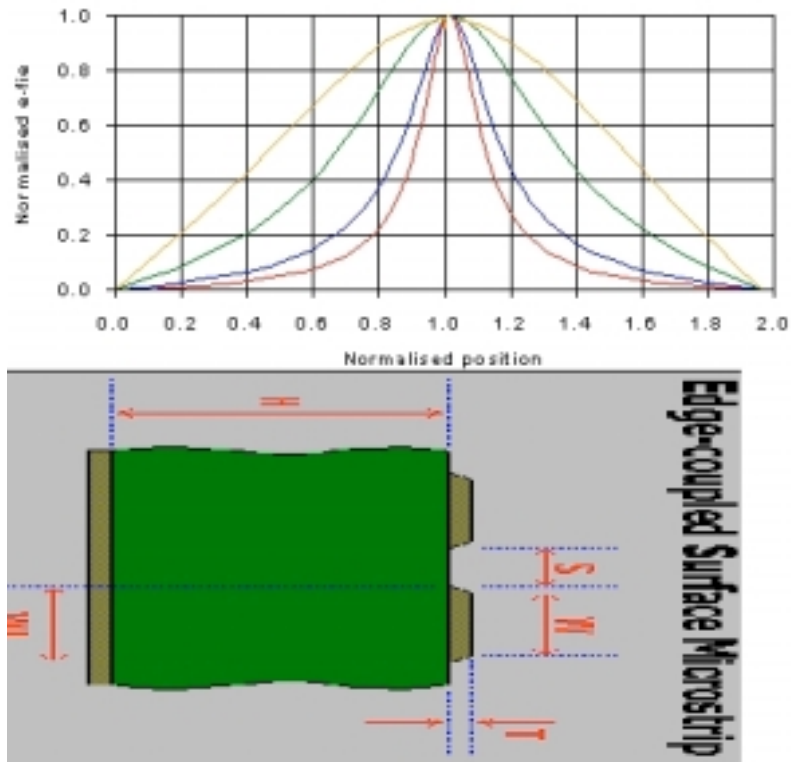
The figure below shows the distribution of Electric field in an Edge coupled surface microstrip structure. The narrow distribution shows the field in a structure where the differential pair is closely spaced, the broader curves show how the field spreads out as the separation of the traces (S) is increased. The actual structure is shown underneath and rotated through 90 degrees to help you visualise the field distribution:

- Look at the red trace, this shows a strong field between the two traces with no electric field strength at the ground plane.
- Now look at the yellow trace, this represents a differential pair with a larger spacing and the field is distributed all the way down to the ground plane.

Remember that FR4 boards are built of layers of core and pre preg material. If a glass layer is close to the surface and the traces are closely spaced (red line on the graph) The field will experience an ϵ_r that is closer to glass than resin.

On inner layers the space between the two traces will fill with resin and a lower effective dielectric constant will result.

- The amount of variation will depend on the board build and your particular PCB shop and their production process.
- To achieve maximum yields you need to work closely with your PCB manufacturer and take into account that because of their composite nature PCB laminates do not exhibit "ideal" theoretical behaviour.



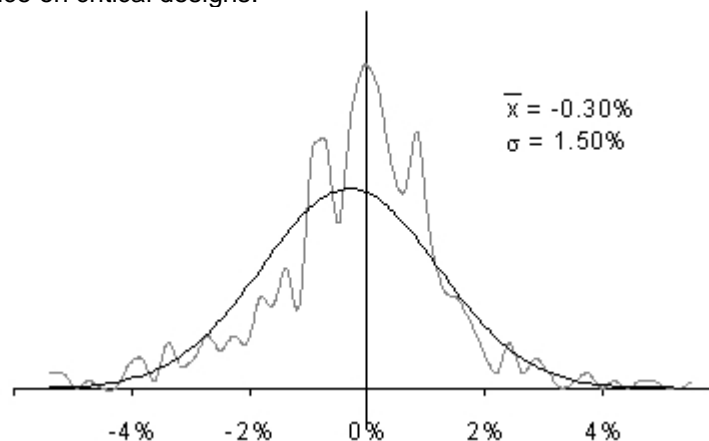
The curve below is taken from actual data used to verify Polar's field solving CITS25 impedance calculator. The overall distribution of error fits the normal curve, but the analysis of the 3 peaks points to the errors from the material properties described above.

- Data based on 1200 samples from 3 independent PCB vendors
- Impedance verified against traceable reference air lines.

Propagation Velocity consideration.

- If propagation time is critical remember:
- $V_p = c / \text{Square root } \epsilon_r$

The variations in Effective ϵ_r will alter propagation velocity and may need to be taken into consideration in addition to impedance on critical designs.



In summary you need to take into account the non ideal electrical properties of substrates especially when designing edge coupled differential structures and co planar designs. It helps to have a good

working relationship between PCB designers and the board fabricators to achieve the highest possible yields. Source: Calculation of the Differential Impedance of Tracks on FR4 Substrates
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